

## DESCRIPTION

The IS341W Photocoupler is ideally suited for driving power IGBTs and MOSFETs used in inverters of motor control and of power supply system. It contains an AIGaAs LED optically coupled to an integrated circuit with a power output stage. The high peak output current of 3.0A is capable to direct drive IGBT with ratings up to 1200 V/100 A. For IGBTs with higher ratings, IS341W can be used to drive a discrete power stage which drives the IGBT gate.

The device is supplied in Stretched SO6 package with wide lead separation.

## FEATURES

- 3.0A Maximum Peak Output Current
- 2.5A Minimum Peak Output Current
- Rail-to-Rail Output Voltage
- 20kV/µs Minimum Common Mode Rejection at  $V_{\text{CM}}$  1500V
- Maximum Propagation Delay 200ns
- Maximum Propagation Delay Difference 100ns
- Wide Operating Voltage Range
  V<sub>CC</sub> 15 to 30 V
- Under Voltage Lock Out (UVLO) Protection with Hysteresis
- Guaranteed Performance over Temperature Range - 40°C to +105°C
- MSL Level 1
- Lead Free and RoHS Compliant
- Safety Approvals Pending

### **APPLICATIONS**

- IGBT/MOSFET Gate Drive
- UPS
- Industrial Inverters
- Switching Power Supplies
- AC Brushless and DC Motor Drives

## **ORDER INFORMATION**

Supplied in Tape & Reel



A 0.1µF bypass Capacitor must be connected between Pins 6 and 4.

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ )

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device.

Exposure to absolute maximum ratings for long periods of time can adversely affect reliability. Input

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Forward Current	25mA
Forward Peak Current (Pulse Width ≤ 1µs, 300pps)	1.0A
Reverse Voltage	5V
Forward Current Rise / Fall Time	500ns
Power dissipation	45mW
Output	
High Level Peak Output Current Exponential waveform. Pulse width ≤ 0.3 µs, f ≤ 15 kHz	3.0A
Low Level Peak Output Current Exponential waveform. Pulse width ≤ 0.3 µs, f ≤ 15 kHz	3.0A
Supply Voltage ( $V_{CC} - V_{EE}$ )	35V
Output Voltage	V <sub>CC</sub>
Power Dissipation	700mW
Total Package	
Isolation Voltage	$5000V_{RMS}$
Total Power Dissipation	745mW
Operating Temperature	-40 to 105 °C
Storage Temperature	-55 to 125 °C
Lead Soldering Temperature (10s)	260°C

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## **Truth Table**

LED	V <sub>cc</sub> – GND (Turn ON, +ve going)	V <sub>cc</sub> – GND (Turn OFF –ve going)	Vo
OFF	0-30V	0-30V	LOW
ON	0 – 11.0V	0-9.5V	LOW
ON	11.0 - 13.5V	9.5 – 12.0V	TRANSITION
ON	13.5 – 30V	12 - 30V	HIGH

## **Recommended Operating Conditions**

Parameter	Symbol	Min	Max	Unit
Operating Temperature	T <sub>A</sub>	- 40	105	°C
Supply Voltage	$V_{CC} - V_{EE}$	15	30	V
Input Current (ON)	I <sub>F(ON)</sub>	7	16	mA
Input Voltage (OFF)	V <sub>F(OFF)</sub>	-3.0	0.8	V

### **ELECTRICAL CHARACTERISTICS** (Typical Values at $V_{CC} - V_{EE} = 30V$ and $T_A = 25^{\circ}C$ , Minimum and Maximum Values at Recommended Operating Conditions, unless otherwise specified)

## INPUT

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Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward Voltage	$\mathbf{V}_{\mathrm{F}}$	$I_F = 10 mA$	1.2	1.37	1.8	V
Forward Voltage Temperature Coefficient	$\Delta V_F / \Delta T$	$I_F = 10 mA$		-1.237		mV/°C
Reverse Voltage	$V_R$	$I_R = 10 \mu A$	5			V
Input Threshold Current (Low to High)	$I_{\rm FLH}$	$V_{CC} = 30V$ $V_O > 5V$		1.8	5	mA
Input Threshold Voltage (High to Low)	$V_{\text{FHL}}$	$V_{CC} = 30V$ $V_{O} < 5V$	0.8			V
Input Capacitance	C <sub>IN</sub>	$V_F = 0V, f = 1MHz$		33		pF

## OUTPUT

Parameter	Symbol	<b>Test Condition</b>	Min	Тур.	Max	Unit
High Level Supply Current	I <sub>CCH</sub>	$I_F = 10 \text{mA}, V_{CC} = 30 \text{V}$ $V_O = \text{Open}$		2.4	3.5	mA
Low Level Supply Current	I <sub>CCL</sub>	$I_F = 0mA$ , $V_{CC} = 30V$ $V_O = Open$		2.5	3.5	mA
High Level Output Current	I <sub>OH</sub>	$V_0 = V_{CC} - 1.5V$ Pulse Width = 50µs			- 1.0	А
		$V_{O} = V_{CC} - 4V$ Pulse Width = 10µs			- 2.5	
Low Level Output Current	I <sub>OL</sub>	$V_{O} = V_{EE} + 1.5V$ Pulse Width = 50µs	1.0			А
		$V_{O} = V_{EE} + 4V$ Pulse Width = 10µs	2.5			
High Level Output Voltage	V <sub>OH</sub>	$I_{\rm F} = 10 {\rm mA}, I_{\rm O} = -100 {\rm mA}$	V <sub>CC</sub> -0.3	V <sub>CC</sub> -0.1		V
Low Level Output Voltage	V <sub>OL</sub>	$I_{\rm F} = 0$ mA, $I_{\rm O} = 100$ mA		$V_{\rm EE}$ + 0.1	V <sub>EE</sub> +0.25	V
UVLO Threshold	V <sub>UVLO+</sub>	$V_{\rm O} > 5V, I_{\rm F} = 10mA$	11.0	12.7	13.5	V
	V <sub>UVLO-</sub>	$V_0 < 5V, I_F = 10mA$	9.5	11.2	12.0	V
UVLO Hysteresis	UVLO <sub>HYS</sub>			1.5		V

# **ELECTRICAL CHARACTERISTICS** (Typical Values at $V_{CC} - V_{EE} = 30V$ and $T_A = 25^{\circ}C$ , Minimum and Maximum Values at Recommended Operating Conditions, unless otherwise specified)

### SWITCHING

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Parameter	Symbol	Test Condition	Min	Тур.	Мах	Unit
Propagation Delay Time to High Output Level	t <sub>PLH</sub>	$I_F = 7 \text{ to } 16\text{mA},$ $V_{CC} = 15 \text{ to } 30\text{V},$	50	130	200	ns
Propagation Delay Time to Low Output Level	t <sub>PHL</sub>	$V_{EE} = 0V$ Rg = 10Ω, Cg = 25nF,	50	130	200	
Pulse Width Distortion $ t_{PHL} - t_{PLH} $ for any given Device	PWD	f = 10 kHz, Duty Cycle = 50%		5	70	
Propagation Delay Difference between any two Devices	PDD		-100		100	
Output Rise Time (10% to 90%)	t <sub>r</sub>			35		
Output Fall Time (90% to 10%)	t <sub>f</sub>			35		
Common Mode Transient Immunity at High Output Level	CM <sub>H</sub>	$I_{F} = 10 \text{ to } 16\text{mA},$ $V_{CC} = 30\text{V}$ $V_{CM} = 1500\text{V},$ $T_{A} = 25^{\circ}\text{C}$	20	25		kV/μs
Common Mode Transient Immunity at Low Output Level	CM <sub>L</sub>	$V_{F} = 0V,$ $V_{CC} = 30V$ $V_{CM} = 1500V,$ $T_{A} = 25^{\circ}C$	20	25		kV/μs

### **ELECTRICAL CHARACTERISTICS** (Typical Values at V<sub>CC</sub> – V<sub>EE</sub> = 10V to 30V and T<sub>A</sub> = 25°C, Minimum and Maximum Values at Recommended Operating Conditions, unless otherwise specified)

### **ISOLATION**

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Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Insulation Voltage	V <sub>ISO</sub>	RH $\leq$ 40% to 60%, t = 1 min, T <sub>A</sub> = 25°C	5000			V
Input - Output Resistance	R <sub>I-O</sub>	$V_{I-O} = 500 VDC$		10 <sup>12</sup>		Ω
Input - Output Capacitance	C <sub>I-O</sub>	$f = 1MHz, T_A = 25^{\circ}C$		0.92		pF

### Note :

- 1. A 0.1uF or bigger bypass capacitor must be connected across pin 6 and pin 4.
- 2. PDD is the difference of Propagation Delays between any two IS341W devices under same test conditions.
- CM<sub>H</sub>, Common Mode Transient Immunity in High stage is the maximum tolerable positive dV<sub>CM</sub>/dt on the leading edge of the common mode impulse signal, V<sub>CM</sub>, to assure that the output will remain high (V<sub>o</sub> > 15V).
- 4.  $CM_L$ , Common Mode Transient Immunity in Low stage is the maximum tolerable negative  $dV_{CM}/dt$  on the trailing edge of the common mode impulse signal,  $V_{CM}$ , to assure that the output will remain low  $(V_0 < 1V)$ .





Fig 1 Forward Current vs Forward Voltage



Fig 3 Supply Current vs Ambient Temperature









Fig 4 Low Level Output Voltage vs Ambient temperature









FHL





12

13 14 15

16











## ORDER INFORMATION

IS341W					
After PN	PN	Description	Packing quantity		
None	IS341W	Stretched SO6 Wide Lead Separation	1000 pcs per reel		

## **DEVICE MARKING**



- IS341W denotes Device Part Number
- denotes Isocom
- YY denotes 2 digit Year code
- WW denotes 2 digit Week code







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- When requiring a device for any "specific" application, please contact our sales for advice.
- The contents described herein are subject to change without prior notice.
- Do not immerse device body in solder paste.

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